

MOSFET

OptiMOS[™] 6 Power-Transistor, 120 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature
- Optimized for high frequency switching and synchronous rectification
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

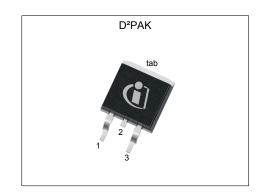
- MSL 1 classified according to J-STD-020

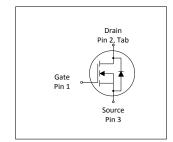


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Hog 1 Official and the Color							
Parameter	Value	Unit					
$V_{ extsf{DS}}$	120	V					
$R_{ extsf{DS(on)}, ext{max}}$	3.5	mΩ					
I _D	138	A					
Qoss	137	nC					
Q _G (0V10V)	58	nC					
Q _{rr} (1000A/µs)	263	nC					











Type / Ordering Code	Package	Marking	Related Links
IPB035N12NM6	PG-TO263-3	035N12N6	-



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatan	Or week at		Value	S			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - -	- - -	138 106 106 23	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =8 V, T_{C} =100 °C V_{GS} =10 V, T_{A} =25 °C, R_{thJA} =40°C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	552	Α	T _C =25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	86	Α	T _C =25 °C	
Avalanche energy, single pulse	E AS	-	-	492	mJ	$I_{\rm D}$ =53 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	246 3.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Dovomotor	Symbol	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.61	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	40	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

	0		Values	s		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	120	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.6	3.1	3.6	V	V _{DS} =V _{GS} , I _D =139 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	3.1 3.5	3.5 4.1	mΩ	V _{GS} =10 V, I _D =86 A V _{GS} =8 V, I _D =43 A
Gate resistance	R _G	0.49	0.98	1.47	Ω	-
Transconductance	g_{fs}	65	130	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 86 A$

Table 5 **Dynamic characteristics**

Doromotor	Cumbal	Values			11	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	4100	5300	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	1200	1600	pF	V _{GS} =0 V, V _{DS} =60 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	23	40	pF	V _{GS} =0 V, V _{DS} =60 V, f=1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	15.5	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =43 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	14.1	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =43 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	24.1	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =43 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	12.8	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =43 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Doromotor	Cumbal	Values			11	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	21	27	nC	V_{DD} =60 V, I_{D} =43 A, V_{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	12.8	16	nC	$V_{\rm DD}$ =60 V, $I_{\rm D}$ =43 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	12.7	19	nC	V _{DD} =60 V, I _D =43 A, V _{GS} =0 to 10 V
Switching charge	Q _{sw}	-	21	-	nC	V _{DD} =60 V, I _D =43 A, V _{GS} =0 to 10 V
Gate charge total ¹⁾	Q g	-	58	73	nC	V_{DD} =60 V, I_{D} =43 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.1	-	V	V_{DD} =60 V, I_{D} =43 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	137	182	nC	V _{DS} =60 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

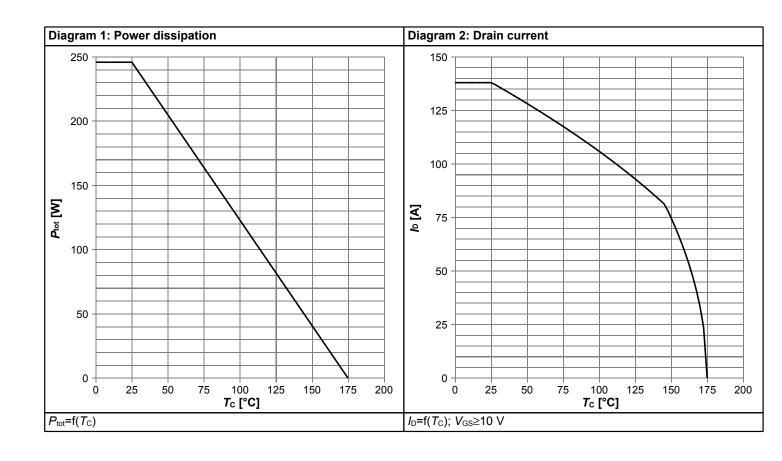


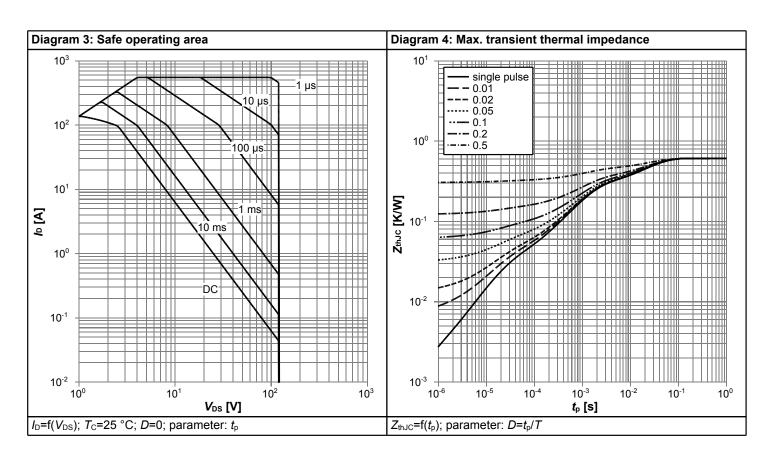
Table 7 Reverse diode

Danamatan	Cross al		Values			Nata / Tank Canadition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	126	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	552	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.90	1.0	V	V _{GS} =0 V, I _F =86 A, T _j =25 °C
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	38	75	ns	V _R =60 V, I _F =43 A, di _F /dt=300 A/μs
Reverse recovery charge ¹⁾	Qrr	-	104	209	nC	V _R =60 V, I _F =43 A, di _F /dt=300 A/μs
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	29	58	ns	V _R =60 V, I _F =43 A, di _F /dt=1000 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	263	526	nC	V_R =60 V, I_F =43 A, di_F/dt =1000 A/ μ s

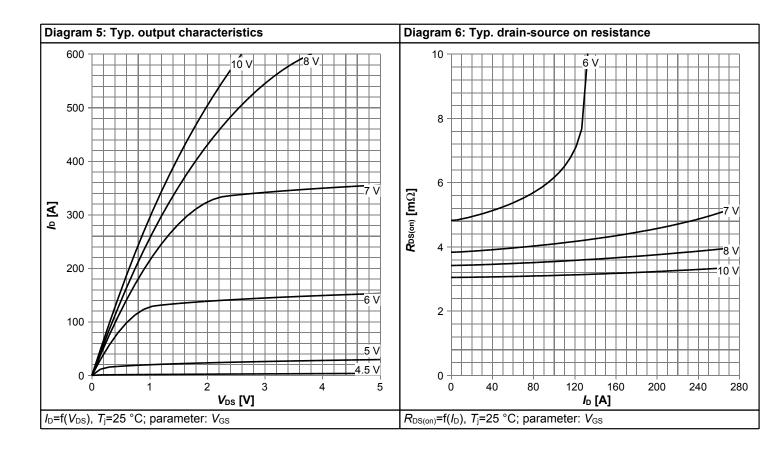


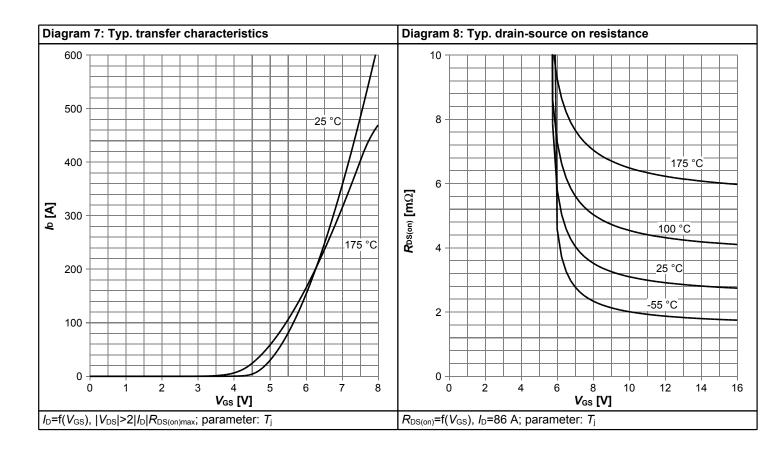
4 Electrical characteristics diagrams



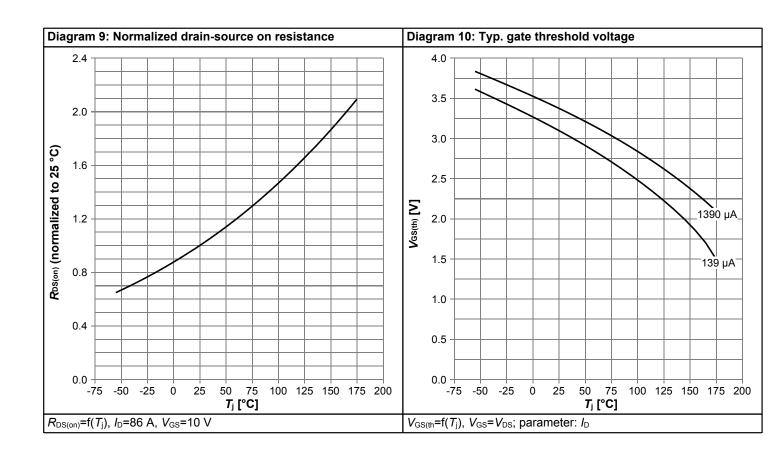


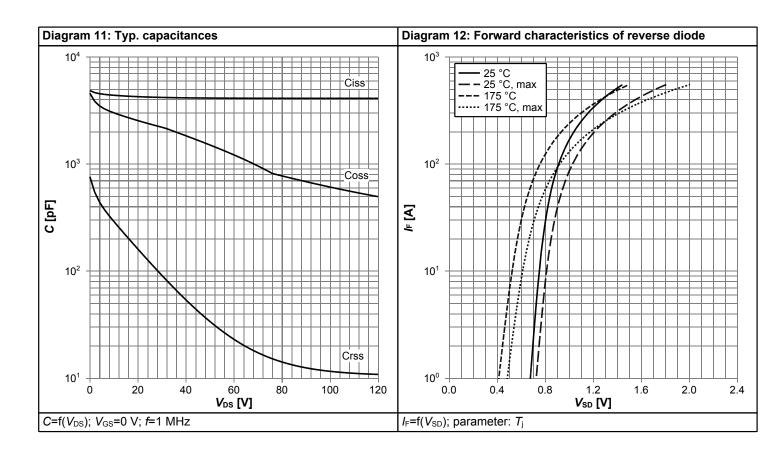




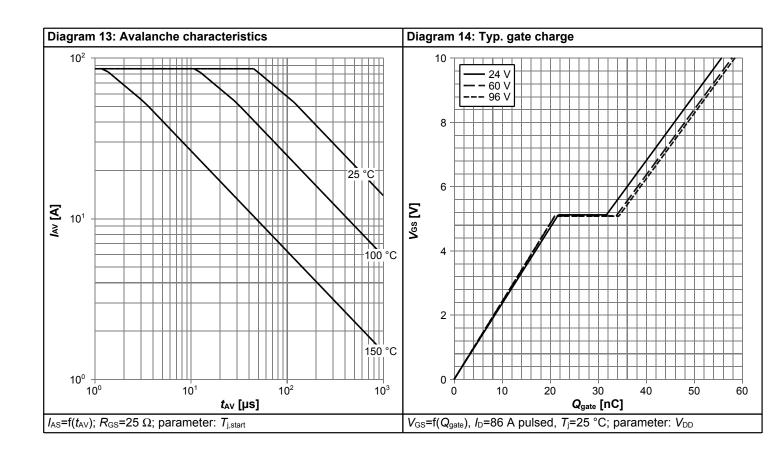


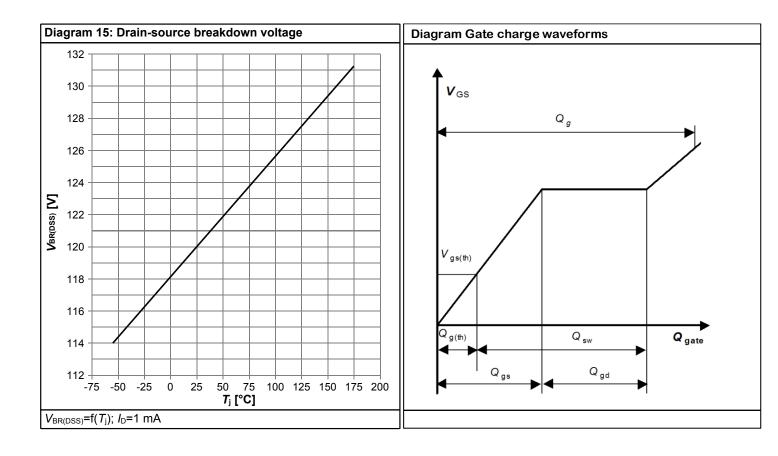






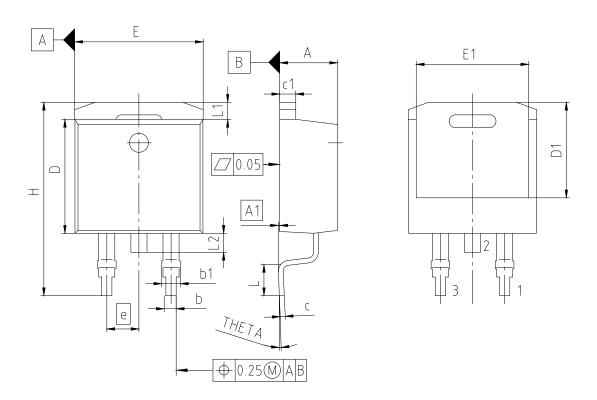








5 Package Outlines



,						
PACKAGE - GROUP NUMBER:	PG-TO263-3-U02					
DIMENSIONS	MILLIMETERS					
DIMENSIONS	MIN.	MAX.				
Α	4.06	4.83				
A1	0.00	0.25				
b	0.51	1.00				
b1	1.07	1.78				
С	0.30	0.73				
c1	1.14	1.65				
D	8.38	9.65				
D1	6.60	7.50				
E	9.65	10.67				
E1	6.22	8.70				
е	2.54					
N	3					
Н	14.60	15.88				
L	1.52	2.60				
L1	1.05	1.68				
L2	1.35	1.78				
THETA	-9.00°	8.00°				

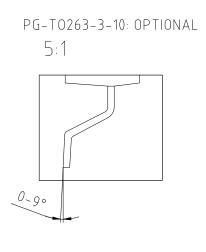


Figure 1 Outline PG-TO263-3, dimensions in mm



Revision History

IPB035N12NM6

Revision: 2023-12-22, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2023-12-22	Release of final version			

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